# **UG10281**

# S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

Rev. 1.0 — 10 July 2025

User guide

#### **Document information**

Information	Content
Keywords	S32E288, 975EVB, Evaluation Board Solution, S32E2 Family Microcontrollers
Abstract	The primary objective of this document is to highlight the functionality of the S32E2 Evaluation Boards (EVBs) for use by software and hardware developers.



S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

#### 1 Overview

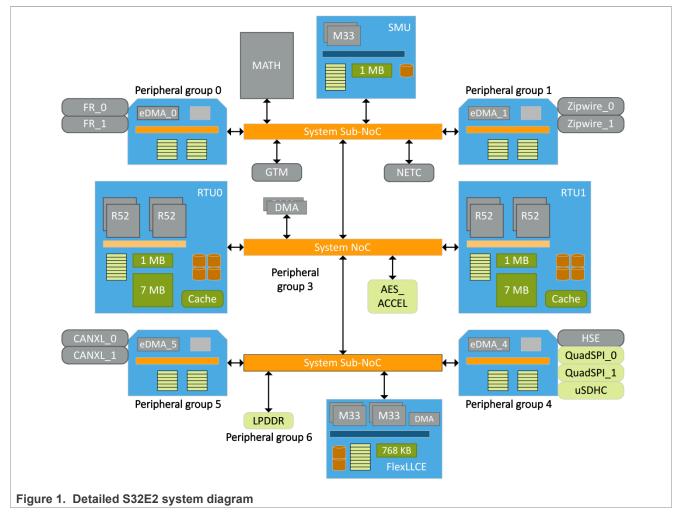
The primary objective of this document is to highlight the functionality of the S32E2 Evaluation Boards (EVBs) for use by software and hardware developers.

The EVBs provide a platform for evaluation and development of S32E2 automotive products – facilitating hardware & software development and providing robust debug capabilities.

Please refer to the board schematics in conjunction to viewing this document.

- SCH-89956 (S32E288-957EVB)
- SCH-54935 (S32X-MB)

**Note:** As revisions change, some of the images may show slight differences from delivered boards. Schematics contain full change lists.



The image above is a system overviews of the S32E2 device. It is a high-end, 32-bit, Arm-based Microcontroller (MCUs), targeting applications related to safety, vehicle dynamics, domain control & HEV/EV systems. It has a wide feature set, requiring an extensive development platform for evaluating the functions available to a user.

This EVB solution was designed by NXP to allow silicon samples to be evaluated, with as much functionality pinned-out and available to the user as possible. In some cases, pins have been dedicated to a particular purpose on these EVBs and may not be available for alternate functions. Where possible, jumper configuration and on-board multiplexing allows for alternate functions to be evaluated.

UG10281

#### S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

The EVB system comprises a common motherboard (S32X-MB) and a daughtercard (S32E288-975EVB). In this manual, the daughtercard used is the S32E288-975EVB which is designed to support the S32E2, which is one of the three unique package options for the S32Z2/E2 family MCUs.

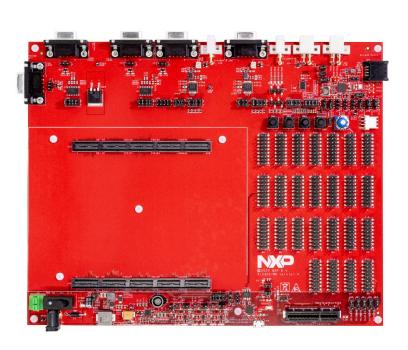


Figure 2. S32X-MB



Figure 3. S32E288-975EVB daughtercard

S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

The daughtercard attaches to the motherboard via long interconnectors on the bottom side of the S32E288-975EVB daughtercard.

The following figure shows the placement of the board on top of the motherboard. The daughtercard extends past the left side of the motherboard. Support posts have been included in the daughtercard kit to support the weight of the overhanging edge of the daughtercard.

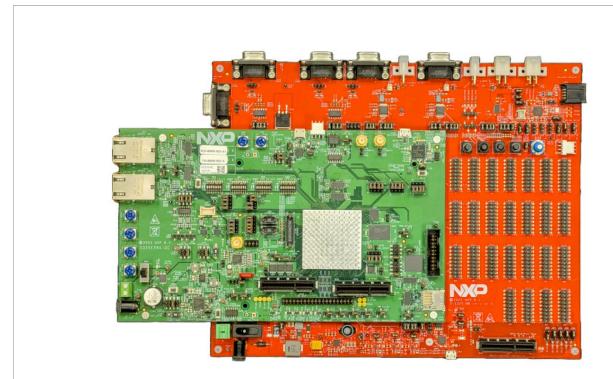


Figure 4. S32X-MB and S32E288-975EVB daughtercard

#### 2 Boot modes

#### 2.1 Introduction

This chapter provides details about different boot options available. This chip supports two boot modes:

- Serial Boot mode from UART (LINFlexD) and CAN(FlexCAN)
- Boot from external flash memory (from QuadSPI flash, SD, or MMC)

Combinations of the following inputs control the boot mode:

- Boot mode pins (BOOTMOD \_0 and BOOTMOD\_1)
- RCON switch Settings

#### 2.2 Serial boot mode

Serial Boot mode is entered via the BOOTMOD input pins. Serial download can also be initiated if the Functional Reset Counter (FREC register in the MC\_RGM module) reaches a value ≥ 8.

In Serial Boot mode, BootROM programs the HSE\_H SWT (Watchdog timer) for a 60 s timeout, then continuously polls for activity on any of the available interfaces:

UG10281

S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

- CAN
- UART

If no activity is detected, the timer expires, and the core is reset.

BootROM sequentially checks for activity on all available interfaces and selects the first serial interface that it identifies as active as the download interface.

Jumpers J124 and J125 are BOOTMOD \_0 / BOOTMOD\_1.

BOOTMOD [1:2] = b01 to select serial boot mode.

To select the serial boot mode:

- 1. Switch OFF the power supply.
- 2. Set the jumpers as shown on the right:
  - J124 : Position (2-3)
  - J125 : Position (1-2)

Please note the following figure (Figure 5) does not reflect serial boot mode. The figure correctly showcases BootROM for boot from external flash memory.

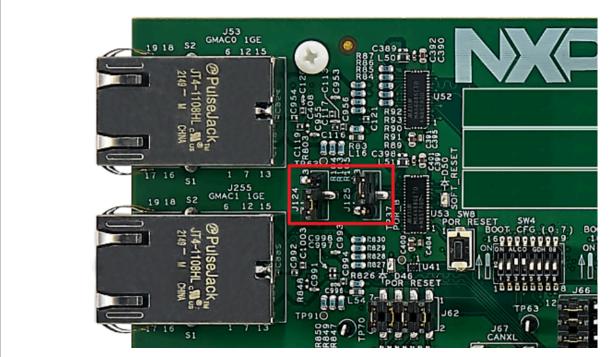


Figure 5. Jumpers J124 and J125 for boot mode selection

#### 2.2.1 FlexCAN

BootROM supports serial download from the FlexCAN module. Communication between the chip and the host (transmitting utility) is done by exchange of data using CAN packets. BootROM supports transfer of data only in non-FD mode.

S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

# 2.2.2 UART(LINFlexD)

BootROM supports boot from the LINFlexD\_9 module, configured in UART mode. The communication between the MCU and the host (transmitting utility) is done by exchange of data through UART packets. LINFlexD\_9 is configured to communicate in 8 bit mode with even parity configuration.

To select LIN 9 for the UART:

- 1. Switch off the power supply.
- 2. Set the Jumper J247 to position 1-2 as shown in the figure.(LIN SEL)

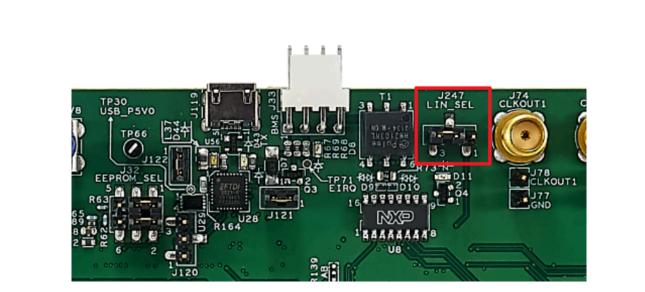


Figure 6. Jumper J247 for selecting LIN(9) for UART

**Note:** This will disconnect RCON switches RCON4 and RCON7. These are needed if doing parallel RCON boot, so return this switch to the default 2-3 position if using RCON boot mode. Switch may be moved to 1-2 position after boot, if desired.

## 2.3 Boot from external flash memory

BootROM supports boot from external flash memory devices over the following interfaces:

- QuadSPI Hyper Flash/Octal Flash/LPDDR4 Flash
- SD/MMC/eMMC via uSDHC interface

In order to boot from the external flash memory devices, the following selections need to be made:

- 1. Enable parallel RCON boot.
- 2. Select the SD/MMC boot modes.

To enable boot from parallel RCON:

- 1. Switch off the power supply.
- 2. Set the jumpers as shown in the above figure- Boot Mode selection Reference:
  - J124 : Position (1-2)
  - J125 : Position (2-3)

S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

#### 2.3.1 QSPI boot mode

To enable QSPI boot mode:

- 1. Switch OFF the power supply.
- 2. Enable the parallel RCON boot.
- 3. Change the below RCON settings to select the corresponding flash memory:

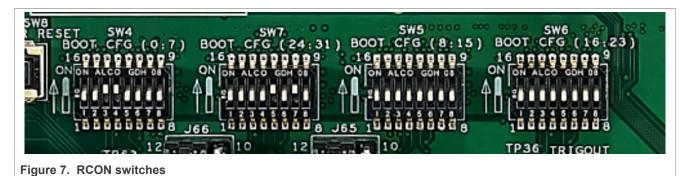
Table 1. RCON settings to select the corresponding flash memory

QuadSPI_Mode	BOOT_CFG[4]	BOOT_CFG[3]	BOOT_CFG[2]
HyperFlash	0	0	1
Octal Flash	0	1	1
LPDDR4 Flash	1	1	1

There are 32 dip switches for selecting the RCON configuration as shown in Figure 7. BOOT\_CFG(0:31) corresponds to RCON switches 1 to 32.

#### 1 - Switch ON

#### 0 - Switch OFF



2.3.2 SD/MMC/eMMC via uSDHC interface

SD/EMMC Boot device selection is controlled by BOOT\_CFG1[7:5] as shown in the following table. To change from QSPI boot mode to SD/MMC Mode:

- 1. Switch OFF the power supply.
- 2. Enable the parallel RCON boot.
- 3. Change the below RCON settings to select the corresponding SD/MMC boot:

Table 2. RCON settings to select the corresponding SD/MMC boot

<b>Boot Options</b>	BOOT_CFG[7]	BOOT_CFG[6]	BOOT_CFG[5]
SD Boot	0	1	0
MMC Boot	0	1	1
Reserved	1	1	1

#### 2.3.3 Additional RCON settings for Clock/Speed/Phase for different boot configurations

For detailed RCON settings – see S32E2\_Fuse\_map in the reference manual. Below RCON settings summarize the switch configuration:

UG10281

# S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

Table 3. Additional RCON settings for Clock/Speed/Phase for different boot configurations

BOOT_ CFG[14]	BOOT_ CFG[13]	BOOT_ CFG[12]	BOOT_ CFG[11]	BOOT_CFG[10]	BOOT_CFG[9]	BOOT_ CFG[8]
	PI CAS (only vali 0-1111:QuadSPI			CK2 0 : CK2 Clock not required 1: CK2 Clock required	Reserved	Serial RCON Detection 1: I2C connected as Serial RCON 0: Parallel RCON

BOOT_CFG[20]	BOOT_CF0	G[19]	-		OOT_ G[17]	BOOT_ CFG[16]	BOOT_CFG[15]
LPDDR4_FLASH_ BNKAV_CFG 0 : No BNKAV config will be done 1: BNKAV config will be done	CKN 0 : Differential Clock not required 1: Differential Clock required	SD Speed 0 - Default Speed 1 - High Speed	QuadSPI PC Delay 000: 300 001: 600use 010: 1000use 011: 2000use 100: 5000us 101: 50000us 110: 100000u 111: 300000us	usec ec ec ec ec ec sec	000: Clo 0' 0' 10 101: 111:5 (only fo	ait Period No Wait 74 ck Cycles 01: 5ms 10:10ms 11:20ms 00:35ms :Reserved Reserved 50ms (max) or SD/MMC/e Configuration)	XOSC BYPASS MODE SEL ECTION: Selects XOSC Mode if XOSC Configuration Fuse is not blown. 0: Reserved 1: Crystal Mode

MMC Boot Modes	BOOT_CFG[19]	BOOT_CFG[20]	BOOT_CFG[21]	BOOT_CFG[22]						
		MMC I	Boot Modes							
		0000- 1-bi	t Normal Speed							
		0001 - 4-bi	t Normal Speed							
		0010 - 8-bi	t Normal Speed							
		0011- 1-b	it HIGH Speed							
		0100 - 4-k	it HIGH Speed							
		0101 - 8-bit HIGH Speed								
		0110 - 4-bit [	DDR HIGH Speed							
		0111 - 8-bit [	DDR HIGH Speed							

BOOT_CFG[23]	BOOT_CFG[22]	BOOT_CFG[21]
•	Data aligned at PosEdge of ata aligned with 2X serial flash	Reserved

#### S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

BOOT_ CFG[30]	BOOT_ CFG[29]	BOOT_ CFG[28]	BOOT_ CFG[27]	BOOT_ CFG[26]	BOOT_CFG[25]	BOOT_CFG[24]
01: Pad lo	00: Reserved opback 10: External DQS	by slave delay	: Selects the Nth y-chain. N can va LLFSMPF] in Qu	ary from 0 to 7.	FSDLY: Full Speed Delay selection. See SMPR[FSDLY] in QuadSPI chapter.	FSPHS: Full Speed Phase selection. See SMPR[FSPHS].

# 3 Daughtercard

The daughtercard (DC) is fully capable of operating stand-alone (i.e. completely disconnected from the motherboard) by means of on-board power management ICs and included 12V AC adapter, or by using external bench power supplies.

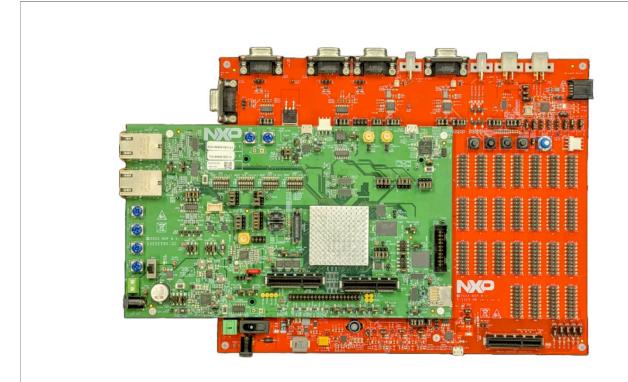


Figure 8. S32X-MB and S32E288-975EVB daughtercard

#### 3.1 Default jumper settings (DC)

The figures below show the default placement of jumpers across the entire board, with each red box notating the placement of each jumper. This is how the DC board should look when initially removed from the packaging. Please note that depending of the PMIC used on the S32E2 board, jumpers J19, J21, and J23 may have slightly different configurations than what is pictured below.

# S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

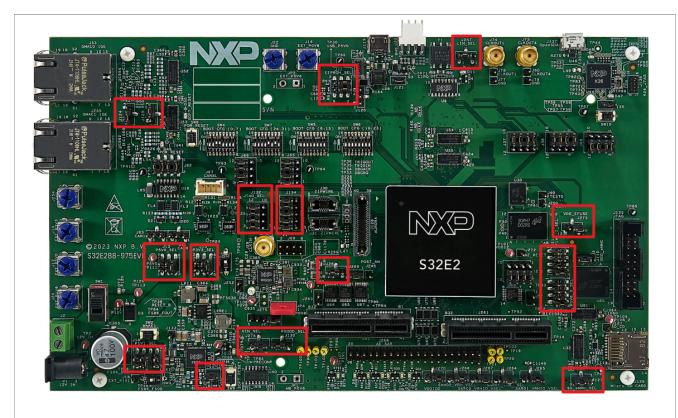


Figure 9. Highlighted default jumper settings

Table 4. List of jumpers

Label from Schematic	Overall Function	Default Configuration	Pins	Pin description	Link to extended description (see section)
P1	12 Volt Power Connector	-	-	-	3.2.3
J2	12 Volt Terminal Block	-	-	-	3.2.3
JPx	0.8V power supply	Dependent on	JP1	MB Supply	3.2
	jumper	System Basis Chip on board	JP2	External Supply	
			JP4	PF5030 Supply	
J12	External 5.0V power plug	-	-	-	3.2.2
J13	5.0V power supply	Pins 5-6	1-2	MB Supply	3.2
	jumper		3-4	External Supply	
			5-6	SBC Supply	
J14	External 3.3V power plug	-	-	-	3.2.2
J15	3.3V power supply	Pins 5-6	1-2	MB Supply	3.2
	jumper		3-4	External Supply	
			5-6	SBC Supply	

# S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

Table 4. List of jumpers...continued

Label from Schematic	Overall Function	Default Configuration	Pins	Pin description	Link to extended description (see section)
J16	External 0.8V power plug	-	-	-	3.2.2
J18	External 1.1 power plug	Open	1	-	3.2.2
J19	1.1V power supply	Pins 3-4	1-2	External	3.2
	jumper		3-4	N/A	
			5-6	PF5030	
			7-8	FS86	
J20	External 1.8V power plug	-	-	-	3.2.2
J21	1.8V power supply	Pins 5-6 OR	1-2	MB Supply	3.2
	jumper	Pins 7-8 *Please note	3-4	External Supply	
		that default	5-6	N/A	
		configuration for this jumper is based of which PMIC is used	7-8	PF5030	
J22	External GND	-	-	-	3.2.2
J23	1.8V power supply jumper	Pins 5-6 OR Pins 7-8 *Please note that default configuration for this jumper is based of which PMIC is used	1-2	MB Supply	3.2
			3-4	External Supply	
			5-6	N/As	
			7-8	PF5030	
J28	Clock In	Pins 2-3	1-2	Enabled	3.3
			2-3	Disabled	
J29	CLOCKIN SMA	-	-	-	3.3
J32	EEPROM Select	1-2	1-2	То МВ	3.9
		3-4	3-4	To MB	
			5-6	EEPROM_SCL EEPROM_SDA	
J33	Battery Management System Interface	-	-	-	-
J53	GMAC0 1GE	-	-	-	3.10
J61	CAN0	Open	1	CAN0_P	3.6
			2	-	
			3	CAN0_N	

# S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

Table 4. List of jumpers...continued

Label from Schematic	Overall Function	Default Configuration	Pins		Pin description	on	Link to extended description (see section)
J63	CAN1	Open	1		CAN1_P		3.6
			2		-	-	
			3		CAN1_N		
J67	CANXL	Open	1		CAN0XL_P		3.7
			2		CAN0XL_N		
			3		CAN1XL_P		
			4		CAN1XL_N		
J74	CLKOUT1 SMA	-	-		-		3.3
J75	CLKOUT4 SMA	-	-		-		3.3
J77	GND	-	-		-		-
J78	CLKOUT1 Pin	Open	1		CLKOUT1		3.3
J79	GND	-	-		-		-
J80	CLKOUT4 Pin	Open	1		CLKOUT4		3.3
J110 VDD_eMMC	Pins 1-2	1-2		1.8V			
			2-3		3.3V		
J119	USB Micro B	-	-		-		3.5
J121	Enable TX LED Pins 1-2		1		USB_TXLED	USB_TXLED	
			2		CBUS0		
J122	Enable RX LED	Pins 1-2 (On)	1 l		USB_RXLED	USB_RXLED	
			2		CBUS1		
J123	SD_eMMC_SEL	Pins 2-3	1-2		SDHC to eMMC		3.8
			2-3		SDHC to SD S	Socket	
J124	BOOT_MODE0	Pins 1-2	1-2		High		3.4
			2-3		Low		
J125	BOOT_MODE1	Pins 2-3	1-2		High		3.4
			2-3		Low		
J127	SD_CD_B	Open	1		SD_CD_B		3.8
J130	PGOOD_SEL	Pins 2-3	1-2		MB Power Go	od	3.1
			2-3		SBC Power G	ood	
			Open		External Power		
J131	SBC_RSTB	Pins 1-2	1 2		RESET_B		3.3.3
					SBC_RSTB		
J132	JTAG_SEL	Pins 2-3	1	2-3	To MB	J_TDI	3.11.2
		Pins 5-6	4	5-6	То МВ	J_TDO	

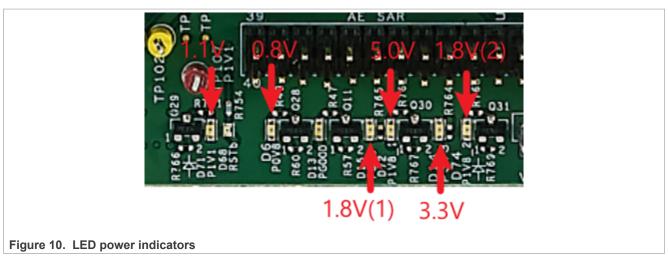
# S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

Table 4. List of jumpers...continued

Label from Schematic	Overall Function	Default Pins Configuration		Pin description		Link to extended description (see section)	
		Pins 8-9	7	8-9	То МВ	J_TCK	
		Pins 11-12	10	11-12	To MB	J_TMS	
J134	JTAG or OpenSDA	Pins 1-2	3	1-2		To 20-pin	3.11
		Pins 4-5	6	4-5		JTAG	
		Pins 7-8	9	7-8			
		Pins 10-11	12	10-11			
		Pins 13-14	15	13-14			
J247	LIN Select	Pins 2-3	1-2		LIN6-9		3.5
			2-3		RCON4, PSI5		1
J252	PF_PWRON	Open	1-2		-		-
J254	External GND	-	-		-		3.2.2
J255	GMAC1 1GE	-	-		-		3.10

# 3.2 Power supply

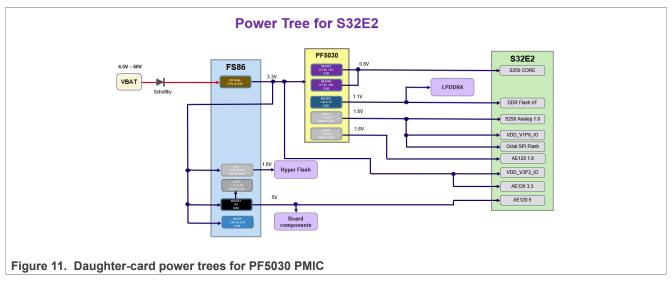
The EVB has five distinct power rails. They are: 5V, 3.3V, 1.8V, 1.1V, and 0.8V. The purpose of each rail is shown by their connections in the diagram below. Each rail has an associated LED to signal when the power rails are working as intended, these will illuminate when power is successfully applied regardless of option used.



Note that by default, everything is configured to be powered by the S32E288-975EVB daughtercard power management ICs.

The S32Z280-400EVB features one System Basis Chip, the NXP FS86 series SBC, and the NXP PF5030 series PMICs. The following figure shows the power-tree connections.

#### S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide



**Note:** The motherboard does not supply 1.1V, so this must be sourced from the daughter-card's PMIC or external supply connector to supply the LPDDR power segment.

The following figure shows power selection jumpers on the DC.

**Note:** Use of FS86 1.1V source setting for Jumper J19 is not supported by the FS86 and may be removed in a future revision of the daughtercard. Do not use this setting.

The following figures show power selection jumpers on the S32E288-975EVB daughtercard.



Please note in the figure 11 above, the jumper is used to select JP4 which corresponds to the PF5030 0.8V power rail. On the S32E288-975EVB daughtercard, this jumper can be moved to three different places (JP1, JP2, and JP4) to receive 0.8V from difference sources.

#### S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

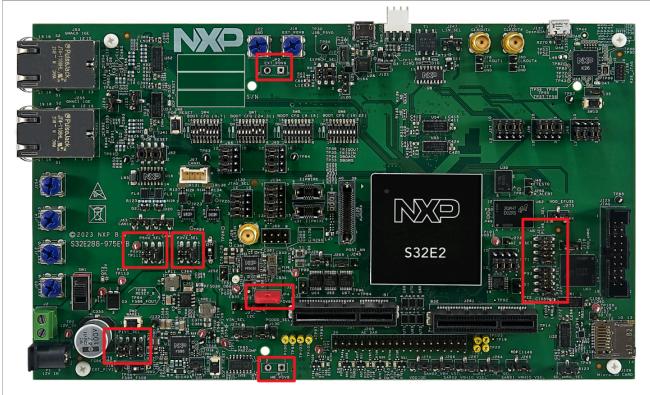


Figure 13. Physical power supply selection jumper

In the schematic below (Figure 13), the possible supply options for each power rail are shown. For the 0.8V power rail, the big red jumper (pictured in Figure 12) can be moved to select the desired supply option for 0.8V. The table below shows the possible configurations:

Table 5. 0.8V Power supply options

Jumper Placement	Voltage Supply Source
JP1	Motherboard
JP2	External Supply
JP4	PF5030

Next, J13 corresponds to the supply options for 5.0V. The table below demonstrates the possible placement of the jumper in order to receive the desired supply of 5.0V.

Table 6. 5.0V Power supply options

Jumper Placement	Voltage Supply Source
Pins 1-2	Motherboard
Pins 3-4	External Supply
Pins 5-6	System Basis Chip

Additionally, J15 corresponds to the supply options for 3.3V. The table below demonstrates the possible placement of the jumper in order to receive the desired supply of 3.3V.

#### S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

Table 7. 3.3V Power supply options

Jumper Placement	Voltage Supply Source
Pins 1-2	Motherboard
Pins 3-4	External Supply
Pins 5-6	System Basis Chip

J19 corresponds to the supply options for 1.1V. The table below demonstrates the possible placement of the jumper in order to receive the desired supply of 1.1V.

Table 8. 1.1V Power supply options

Jumper Placement	Voltage Supply Source
Pins 1-2	External Supply
Pins 3-4	N/A
Pins 5-6	PF5030
Pins 7-8	FS86

J21 and J23 correspond to the supply option for 1.8V. Two separate jumpers are needed in order to deliver the proper 1.8 power supply. It is important to note that pins 5-6 and pins 7-8 correspond the two different options of possible PMICs on the S32E288-975EVB. The board will only have one PMIC, so place the jumper on the pins that correspond to the PMIC on the S32E288-975EVB if supplying from the PMIC is desired. The tables below demonstrate the possible placement of the jumpers in order to receive the desired supply of 1.8V.

Table 9. 1.8V Power supply options

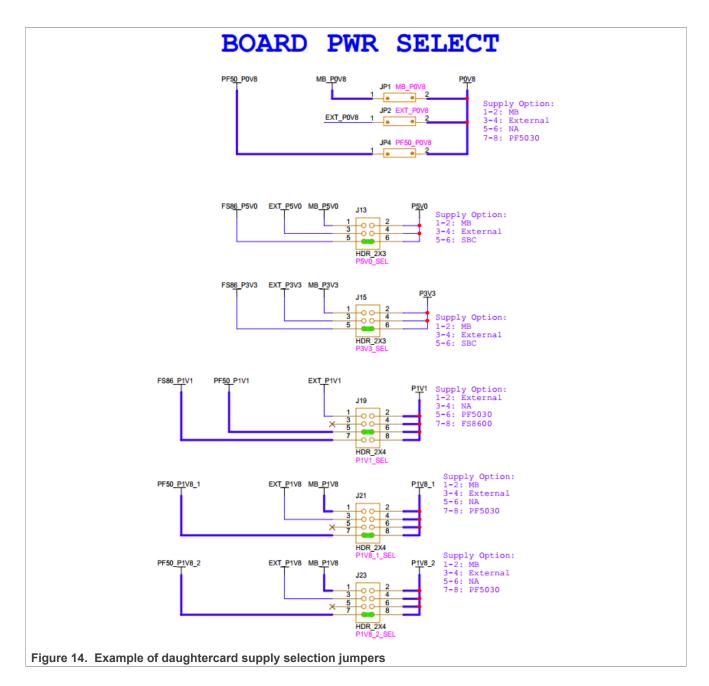
Jumper Placement	Voltage Supply Source
Pins 1-2	Motherboard
Pins 3-4	External Supply
Pins 5-6	N/A
Pins 7-8	PF5030

Table 10. 1.8V Power supply options

Jumper Placement	Voltage Supply Source
Pins 1-2	Motherboard
Pins 3-4	External Supply
Pins 5-6	N/A
Pins 7-8	PF5030

Lastly, please note the green highlight in Figure 14 represents the default configuration of the board.

S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide



#### 3.2.1 Power from motherboard

The primary purpose of the motherboard when used with S32E288-975EVB daughtercard is to provide additional I/O pin-out and communication transceivers, however, it is also capable of supplying 5V, 3.3V, 1.8V, and 0.8V from its own regulators. As noted previously, the motherboard does not supply 1.1V for the daughtercard requiring LPDDR power.

For best use of the S32E288-975EVB daughtercard, it is recommended to use the daughtercard power supplies since the daughtercard can ensure all proper power segments. However, as shown in the tables above, it is possible to select power supplies from the motherboard or externally.

S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

# 3.2.2 Power from multiple external supplies

To power the daughtercard from individual external supplies, e.g., a bench supply unit, each rail must be plugged into its corresponding screw terminal. Please use the schematic in Figure 14 or the tables above to use the proper pins for each power selection jumper in order to configure the board for external power supply.

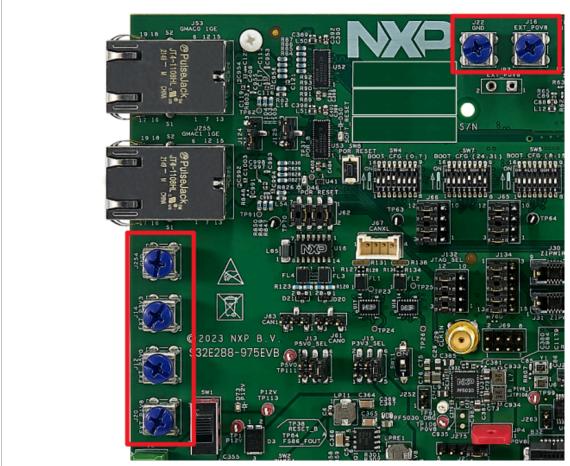


Figure 15. Contacts for individual external supplies

#### 3.2.3 Power from SBC/PMIC

On the EVB we use the NXP FS86 SBC in conjunction with the PF5030 PMIC.

To receive all power rails from a single external supply, a 12V source must be plugged into the daughtercard via barrel jack P1 or terminal block J2. The 12V supply is used to power the SBC which, together with the PMIC, generates all the required voltages.

S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide



Figure 16. 12V Connections into FS86 SBC

The SBC and PMIC are pre-programmed via fuses to provide the required voltages and correct power sequence.

#### 3.2.4 SBC debug mode

The SBC/PMIC solution includes hardware watchdogs that can reset the board and MCU if not serviced by application software. Normally, during development, it is desirable to disable this feature to allow application debug without interference from the watchdogs. This is accomplished by setting SW3 & SW11 to the "ON" position.

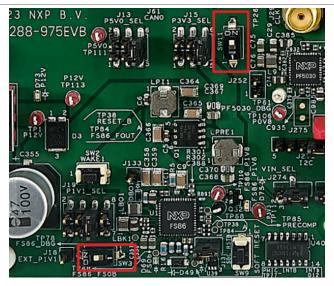


Figure 17. SBC and PMIC jumpers

S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

#### 3.3 Clock and reset

#### 3.3.1 Clocking

There are three clocking options on the daughtercard, configured by R59 and R807. R59 has two configurable positions, connect 1-2 or connect 3-2, or can be left unpopulated (this is the default). R807 is initially installed but can be removed to use external clock options.

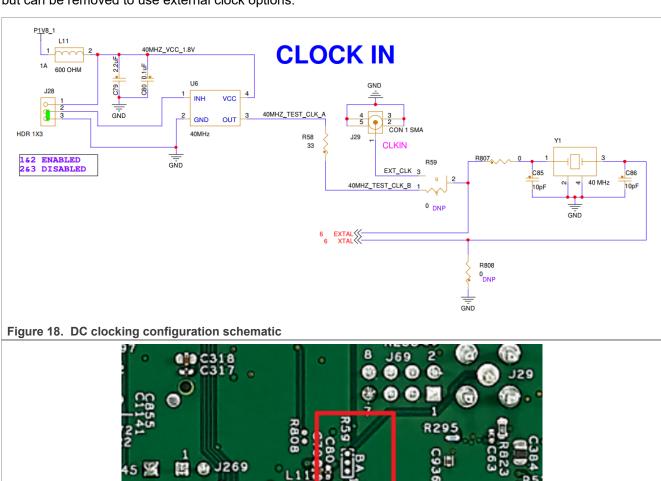


Figure 19. Physical DC clocking configuration-1

2

#### S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

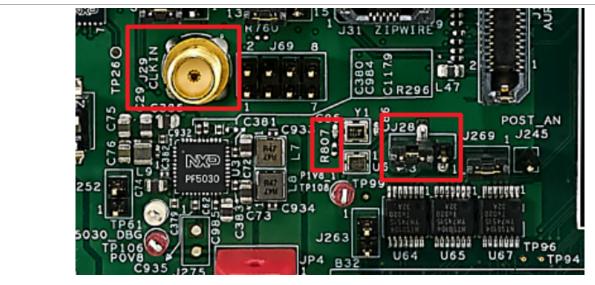


Figure 20. Physical DC clocking configuration-2

The clocking options on the EVB are as follows:

#### 3.3.1.1 40MHz Crystal

To use the 40MHz clock from the crystal, R59 must be left unpopulated, and R807 must be installed. This is the default configuration.

#### 3.3.1.2 40MHz OSC

To use the 40MHz clock from the oscillator chip, R59 must be configured in position 1-2, and R807 must be removed. Header J28 can then be used to enable the chip, by connecting pins 1&2.

#### 3.3.1.3 External SMA

To use an external clock with a custom frequency, R59 must be configured in position 3-2, and R807 must be removed. The external clock is connected to the SMA connector J29.

Table 11. Summary of resistor positions for different clocks

Clock Source	R59	R807
40MHz Crystal	Removed	installed
40MHz OSC	1-2	Removed
External SMA	3-2	Removed

#### 3.3.2 Reset

The daughtercard contains two reset switches: POR RESET and SOFT RESET.

#### **3.3.2.1 POR RESET**

The open-drain POR\_B pin on the S32E288-975EVB daughtercard is a device reset source which can be externally triggered using the POR RESET switch on the daughtercard (Figure 21), or driven low by the SBC if it is determined that the device requires a reset, due to a low-voltage condition for example.

UG10281

S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

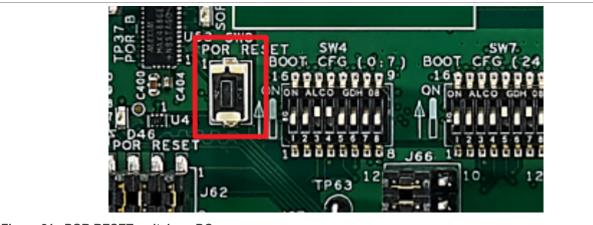


Figure 21. POR RESET switch on DC

When operating from an external power supply, header J130 must be opened for correct operation of the POR RESET switch.

#### 3.3.2.2 Functional reset

To trigger a functional reset, the SOFT\_RESET switch on the S32E288-975EVB daughtercard is used. This triggers a signal to SOFT\_RESET and RESET\_B. When operating from an external power supply, header J131 must be opened for correct operation of the SOFT RESET switch.



Figure 22. Functional reset switch on S32E288-975EVB daughtercard

#### 3.4 RCON switches

There are four banks of dip switches on the S32E288-975EVB daughtercard, each with eight switches, giving a total of 32 switches in total. These switches are used for configuring the boot options of the S32E2 device. To boot from Flash and allow for debug connection the switches should be placed in the correct positions as described in the boot modes section:



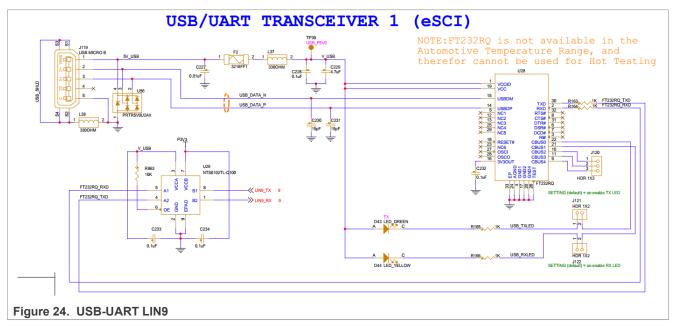
Figure 23. Default RCON switch positions for flash boot

UG10281

S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

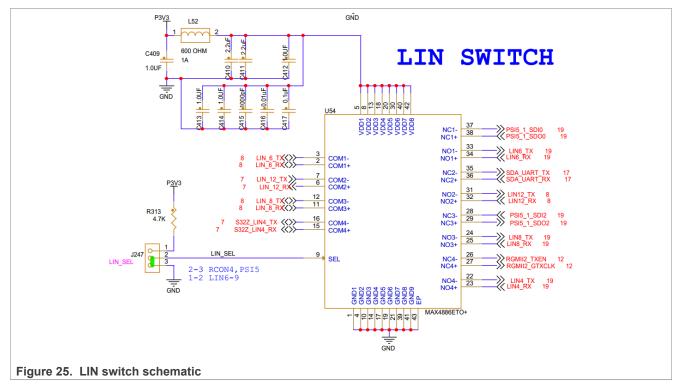
#### 3.5 LIN

The S32E288-975EVB's LIN9 interface is dedicated to the daughtercard USB-UART. This interface may also be used as a serial boot source.



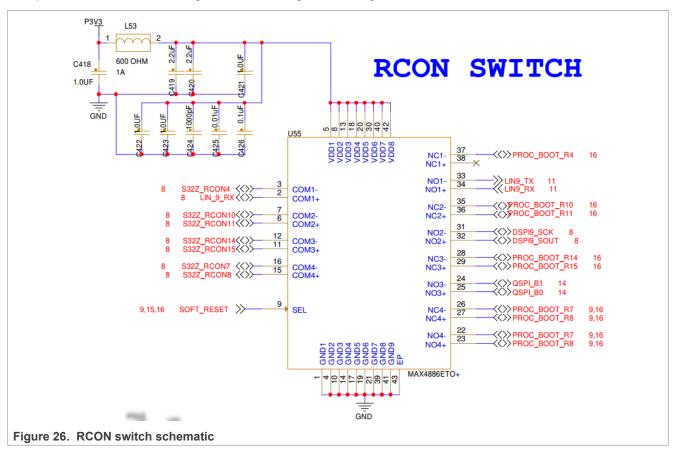
The S32E288-975EVB's remaining LIN interfaces are multiplexed with alternate functions. Routing of LIN signals is accomplished via several on-board multiplexers and jumper blocks.

Component U54 provides selecting between LIN signals and a combination of RCON and PSI-5 signals. This is controlled by jumper J247. By default, LIN6-9 are selected.



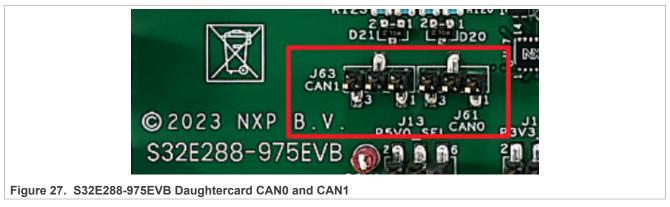
S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

Component U55 includes among several other signals, routing for LIN12.



#### 3.6 CAN

Header J62 is used to connect CAN0 and CAN1 instances to CAN-FD transceivers on the daughter-card. CAN bus-level signals are then available on pin headers J61 and J63 for these two CAN instances.



The CAN0 interface also allows the user to perform a serial boot even when using the daughtercard stand-alone (disconnected from the motherboard).

Remaining CAN interfaces not dedicated to other functions on the daughter-card, are routed to the motherboard connectors.

S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

#### 3.7 CAN-XL



Figure 28. CANXL connector

S32E288-975EVB includes two CAN modules supporting the upcoming CAN-XL standard. The daughter-card has reserved space for two NXP CAN-XL transceivers to be released soon. Signals CANXL\_0\_RX/TX and CANXL\_1\_RX/TX are routed to SO-14 package footprints with CAN bus physical signals available on jumper J67.

#### **3.8 SDHC**

An alternative solution for booting is to use an SD card. For this use, the daughtercard contains a micro SD card socket. J123 is used to switch the device's SDHC connection to either this micro SD card socket (connect pins 2&3), or the GPIO headers on the motherboard (connect pins 1&2).

Table 12. MCU GPIO pin numbers for SDHC signals

SDHC Signal	MCU GPIO Pin
SD_CLK	GPIO111
SD_CMD	GPIO106
SD_DATA0	GPIO107
SD_DATA1	GPIO108
SD_DATA2	GPIO109 <sup>*</sup>
SD_DATA3	GPIO110

<sup>\*</sup>SD\_DATA2 also requires Jumper J249 in the 1-2 position.

S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

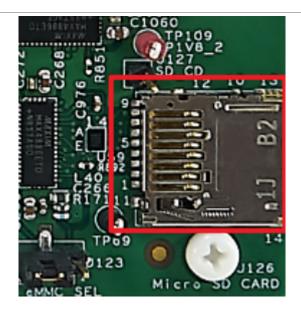


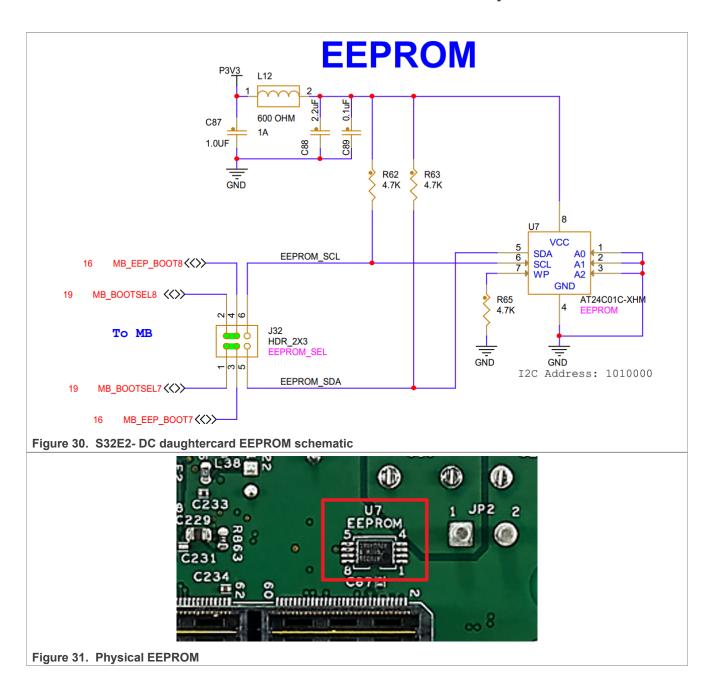
Figure 29. Micro SD socket

This is an alternate solution for booting where this interface can be used to perform a boot from the SD card.

#### 3.9 EEPROM

Header J32 is used to connect MCU GPIO pins to either the motherboard (default configuration), or to SDA and SCL of the daughtercard's EEPROM chip, allowing I2C access to the 8192 bits of serial Electrically Erasable and Programmable Read-Only Memory (EEPROM) located in chip U7. This provides support for Serial RCON, allowing the user to store boot configuration and load with Serial RCON via I2C, an alternative that uses fewer pins than the parallel RCON option.

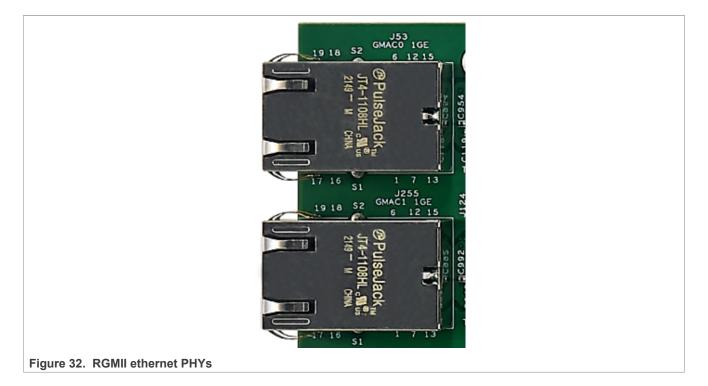
S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide



#### 3.10 Ethernet

The daughtercard includes two 1Gbps RGMII Ethernet PHY (U12 and U58) connected to ETH0 and ETH1 interface on the MCU:

S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

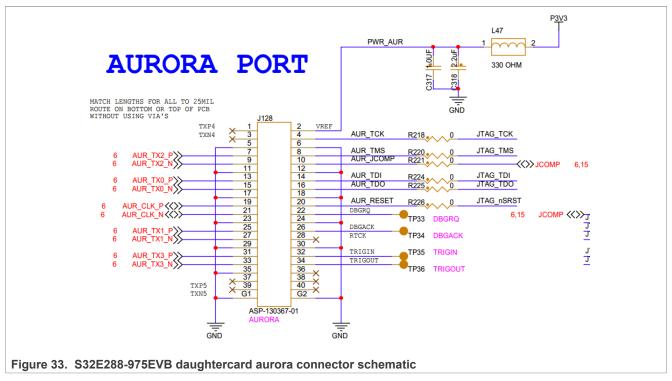


#### 3.11 Debug

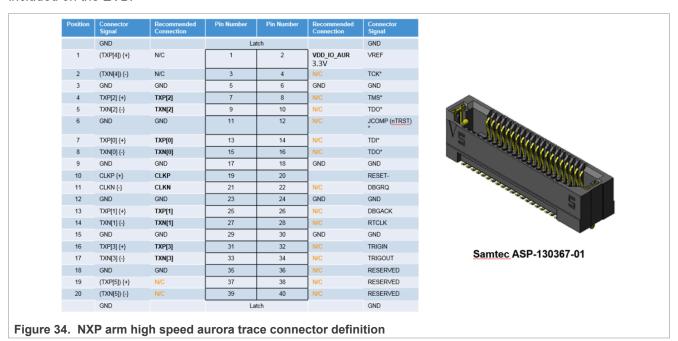
#### 3.11.1 Aurora

The daughtercard contains a connector (J128) for the Aurora Trace Port, allowing debug information to be sent over a high-speed serial link. The five differential pairs from the connector (four TX and one Clock) are connected directly to the MCU.

#### S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide



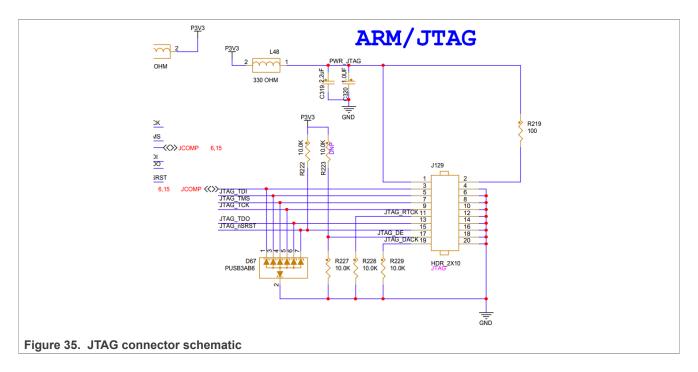
The following figure shows the definition of Aurora trace connections with the recommended connector currently included on the EVB.



#### 3.11.2 JTAG

A JTAG debug port is included on the S32E288-975EVB daughtercard (J129). The standard 20-pin 2.54mm (0.10") JTAG connector is used here.

#### S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide



#### 3.11.3 Lauterbach debuggers

The newest Lauterbach debug hardware for Aurora and JTAG setup for use with S32E devices is as follows:

- LA-3520 + LA-3521 + LA3505 + LA3000
  - Up to 6 lanes (LA-3522 supports 8)
  - Up to 12.5 Gbps/lane



Figure 36. Lauterbach hardware setup

S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

#### 3.11.4 OpenSDA

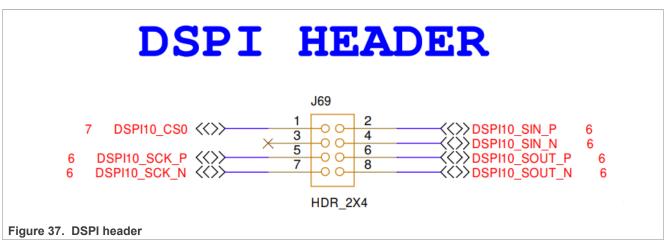
There is an OpenSDA interface included on the board. However, by default the chip required to use this interface is not populated. It is an option to have the module future revisions of this board may support this feature.

#### 3.11.5 Other

Aurora trace tools are also available from other vendors, such as Green Hills and PLS. JTAG only tools are available from multiple vendors, including NXP and Green Hills.

#### 3.12 SPI

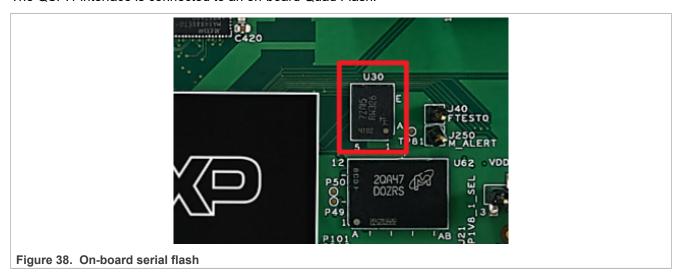
DSPI 10 is available on the daughter-card on J69. The remaining DSPI instances are routed to pins on the motherboard.



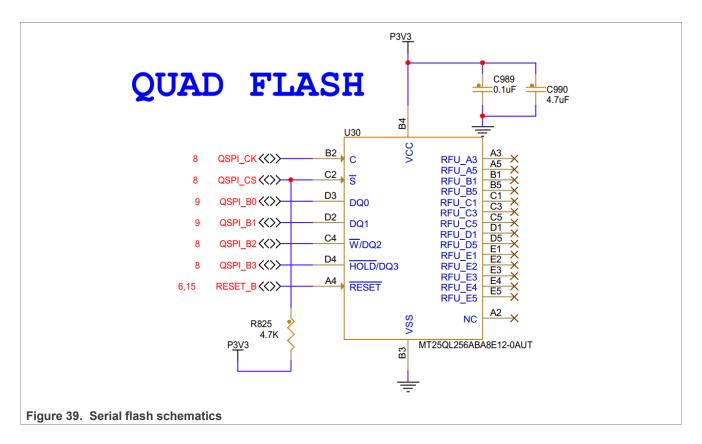
Note: 200MHz DDR QSPI is not supported on the socketed EVB Board.

## 3.13 Flash

The QSPI1 interface is connected to an on-board Quad Flash.



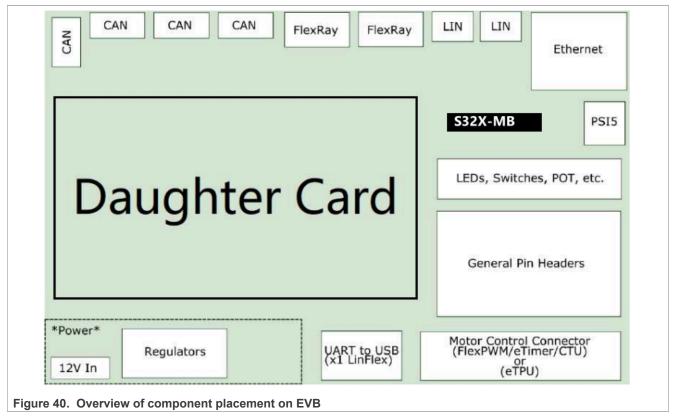
S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide



#### 4 Motherboard

Figure 40 shows the general placement of components of the motherboard. Please refer to Appendix B at the bottom of this document for a full overview.

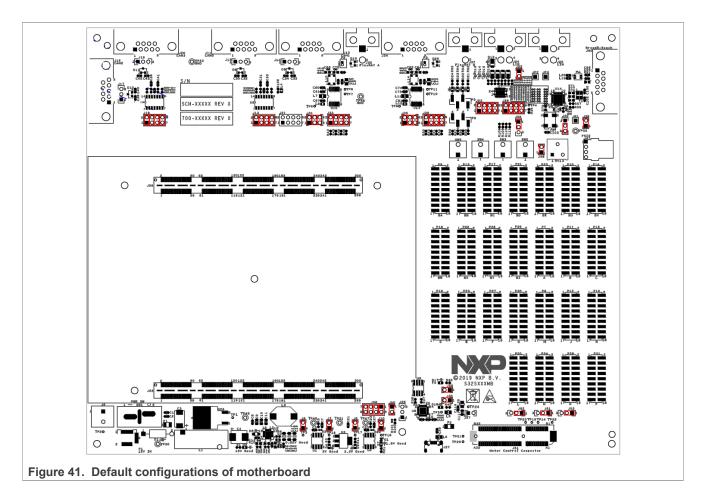
#### S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide



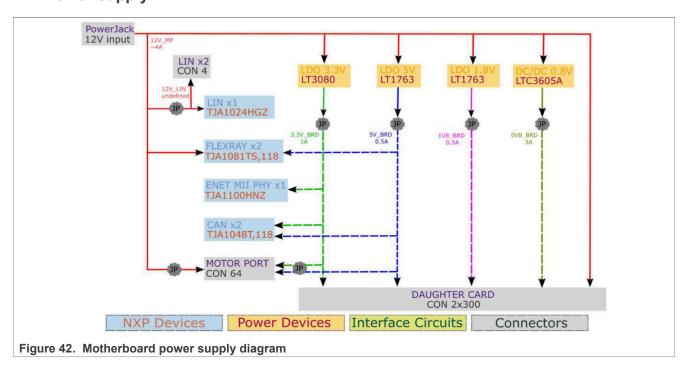
Default Jumper Settings (MB)

Figure 39 shows the default placement of jumpers for the entire motherboard, with each red box notating the placement of each jumper. This is how the motherboard should look once removed from the packaging. Note that there may slight differences between new boards, since some of the jumper placements are done by hand at manufacture.

#### S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide



#### 4.1 Power supply



UG10281

#### S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

The motherboard is powered from a 12V supply, via either the barrel jack connector P1 or the terminal block J6). The 12V supply is used to supply regulators for power rails: 5V, 3.3V, 1.8V and 0.8V, each with a corresponding status LED to show that the rail is working properly.

Note that S32E288-975EVB requires 1.1V supplied for LPDDR power. The Motherboard does not include a regulator for 1.1V. This must be supplied either on the daughter-card's external supply inputs or using the daughter-card's on-board SBC/PMIC.



Headers J7-J10 are set by default to enable the distribution of power from each regulator – removing the jumper isolates the rail from the motherboard.

Table 13. Enable/disable headers for MB power rails

Power Rail	Enable/Disable Header
5V	J7
0.8V	J8
3.3V	J9
1.8V	J10

#### 4.2 CAN

The S32E288-975EVB device has 24 FlexCAN modules implementing the CAN 2.0B and FD CAN protocols.

S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

#### 4.2.1 CAN 0-3

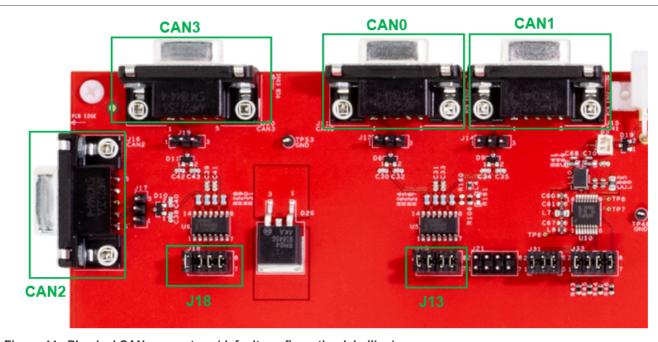


Figure 44. Physical CAN connectors (default configuration labelling)

The EVB motherboard contains four CAN connectors and two <u>TJA1048</u> transceiver modules – each module providing a dual high-speed interface between the physical two-wire CAN buses and the protocol controller of the MCU. TJA1048 supports CAN FD up to 5Mbps for the data phase.

The TX/RX outputs of the TJA1048 modules are connected by default via J13 and J18 to CAN ports 2, 3, and 5 of the MCU, also available as the following GPIO pins, both available on the general access headers on the motherboard, and connected to the daughtercard. The motherboard schematic lists these CAN interfaces as CAN0 through CAN3, however they are connected to CAN instances 2, 3, and 5 on the S32E288-975EVB daughtercard. The following table shows this mapping and also the MCU GPIO pin number for each signal.

Table 14. Default DC CAN mapping and MCU GPIO pin numbers for MB CAN instances 0-3

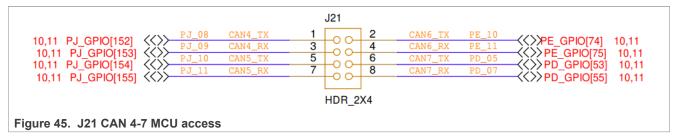
MB CAN Signal	DC CAN Signal	MCU GPIO Pin
CAN0_TX	CAN5_TX	GPIO[76]
CAN0_RX	CAN5_RX	GPIO[77]
CAN1_TX	CAN12_TX	GPIO[127]
CAN1_RX	CAN12_RX	GPIO[128]
CAN2_TX	CAN2_TX	GPIO[24]
CAN2_RX	CAN2_RX	GPIO[25]
CAN3_TX	CAN3_TX	GPIO[34]
CAN3_RX	CAN3_RX	GPIO[35]

#### 4.2.2 CAN 4-7

Header J21 provides direct access to CAN ports 6, 9, and 10 of the MCU, with no transceiver module. However, jumper wires can be used to connect any of these ports to the inputs/outputs of the TJA1048 modules as described in Section <u>5.2.1</u> via headers J13 and/or J18.

UG10281

#### S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide



The motherboard schematic lists these CAN interfaces as CAN4-7 but they are mapped to CAN instances 6, 9, and 10 on the S32E288-975EVB daughtercard as follows:

Table 15. MCU CAN instance and GPIO pin numbers for MB CAN instances 4-7

CAN Signal	MCU GPIO Pin	MCU GPIO Pin
CAN4_TX	CAN6_TX	GPIO[138]
CAN4_RX	CAN6_RX	GPIO[139]
CAN5_TX	Not Connected	
CAN5_RX	Not Connected	
CAN6_TX	CAN10_TX	GPIO[146]
CAN6_RX	CAN10_RX	GPIO[147]
CAN7_TX	CAN9_TX	GPIO[159]
CAN7_RX	CAN9_RX	GPIO[160]

#### 4.3 LIN

S32E2 contains 13 LINFlexD modules, LIN0-11 and MSC\_0\_LIN. The EVB contains connections to four of these modules as well as a <u>TJA1024</u> quad LIN transceiver module, interfacing between the physical LIN buses and the protocol controller of the MCU.

#### S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

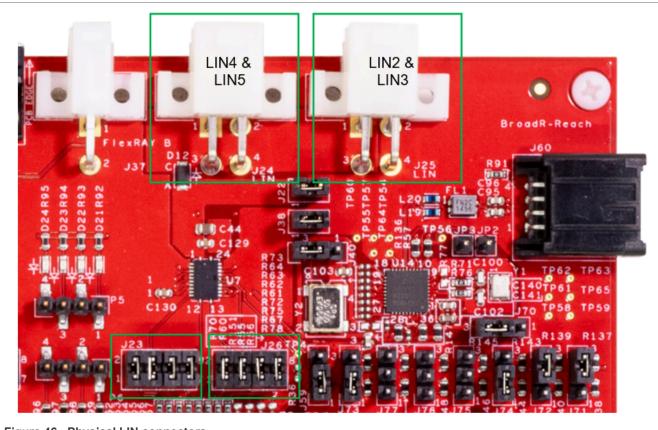


Figure 46. Physical LIN connectors

The four LIN ports are connected by default via J23 & J26 to LIN instances and GPIO pins on the MCU, both available on the general access headers on the motherboard and connected to the daughtercard. In the motherboard schematic, these four LIN ports are referred to as LIN2-5. The following table maps these LIN instances to the LIN modules on the MCU and associated GPIO pins.

**Note:** Motherboard LIN3 is not directly connected to the daughter-card due to routing constraints. However, it is possible to connect to the general access headers with J26.

Table 16. MCU LIN module and GPIO pin numbers for MB LIN signals

Motherboard LIN	MCU LIN Signals	MCU GPIO Pin
LIN2_TX	LIN8_TX	GPIO[125]
LIN2_RX	LIN8_RX	GPIO[126]
LIN3_TX	Not Connected	Not Connected
LIN3_RX	Not Connected	Not Connected
LIN4_TX	LIN4_TX	GPIO[31]
LIN4_RX	LIN4_RX	GPIO[32]
LIN5_TX	LIN5_TX	GPIO[36]
LIN5_RX	LIN5_RX	GPIO[37]

S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

#### 4.4 USB/UART

The USB/UART section of the motherboard allows the user to connect to the board and start up a serial terminal with just a USB cable, avoiding the need for any RS232 to USB converters (USB types may change between board revisions).

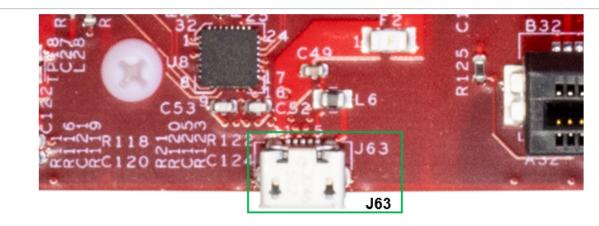


Figure 47. J63 UART Connector

#### 4.5 FlexRay

S32E288-975EVB contains two FlexRay communication controller modules that implement FlexRay Protocol Specification 2.1A. The connectors available on the EVB are J32 for FlexRay\_A, J37 for FlexRay\_B, and J34 for a joint connection. The EVB contains a <u>TJA1081</u> transceiver module for each FlexRay, providing an advanced interface between the physical buses in the network and the protocol controller of the MCU.

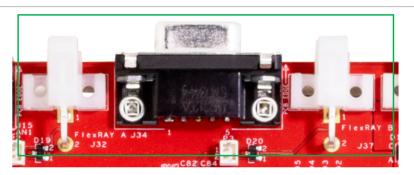


Figure 48. Physical FlexRay connectors

Header J31 for FlexRay\_A and J35 for FlexRay\_B are used to enable and route the FlexRay signals from the transceiver modules to the following GPIO pins, both available on the general access headers on the motherboard and connected to the daughtercard. The following table maps motherboard FlexRay signals to MCU FlexRay instances and GPIO pins.

Table 17. MCU GPIO pin numbers for FlexRay signals

MB FlexRay Signal	MCU FlexRay Signal	MCU GPIO Pin
FLXR0A_TXEN	FR0_TXE_A_B	GPIO[6]
FLXR0A_TXD	FR0_TXD_A	GPIO[7]
FLXR0A_RXD	FR0_RXD_A	GPIO[8]
FLXR0B_TXEN	FR1_TXE_A_B	GPIO[15]

UG10281

#### S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

Table 17. MCU GPIO pin numbers for FlexRay signals...continued

MB FlexRay Signal	MCU FlexRay Signal	MCU GPIO Pin
FLXR0B-TXD	FR1_TXD_A	GPIO[16]
FLXR0B-RXD	FR1_RXD_A	GPIO[17]

Header J33 for FlexRay A and J36 for FlexRay B are used to configure the operating mode of the transceiver modules by setting pins STBN and EN. By default, both pins are high, so the module is operating in Normal mode. Using jumper wires, the following table shows the other possible configurations.

Table 18. TJA1081 FlexRay transceiver module mode select

Mode	STBN	EN
Normal	1	1
Receive Only	1	0
Go to Sleep	0	1
Sleep	0	0

Note that both pins have internal pull-down resistors, so if the jumpers are left floating the module will enter Sleep mode.

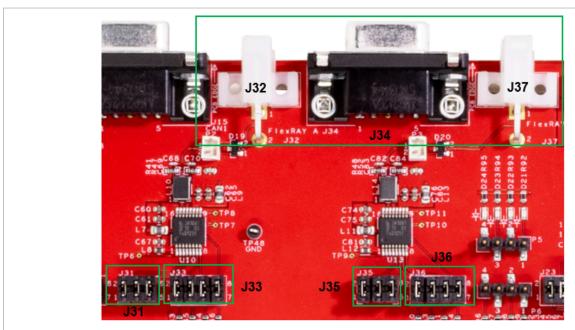


Figure 49. FlexRay connectors and enable and mode select jumpers

#### 4.6 Ethernet

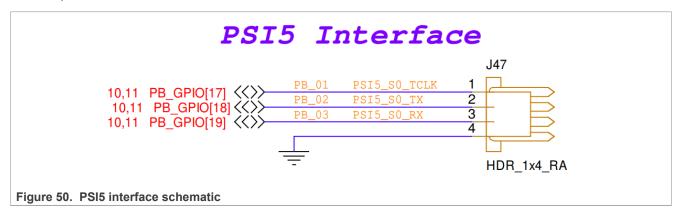
S32E288-975EVB daughtercard contains two NET Controller (NETC) dual Ethernet module. It is capable of 10/100/1000 Mbps MII/RMII/RGMII.

The S32E288-975EVB daughtercard provides two Gigabit Ethernet PHY connected to ETH0 and ETH1 interface on the MCU. All Ethernet capabilities are on the daughtercard. There are no Ethernet connections to the motherboard.

S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

#### 4.7 PSI5

There is one PSI5 instance from the S32E288-975EVB accessible on the Motherboard. To connect to the PSI5 instance, connector J47 is used.



The MCU GPIO pins connected to J47 are as follows, both available on the general access headers on the motherboard, and connected to the daughtercard.

Table 19. MCU GPIO pin numbers for PSI5 signals

PSI5 Signal	MCU GPIO Pin
PSI5_S_0_TCLK	GPIO[25]
PSI5_S_0_TX	GPIO[23]
PSI5_S_0_RX	GPIO[24]

**Note:** Daughtercard jumper block J68 must have positions 4-5 and 7-8 closed to route PSI5 signals here to the motherboard.

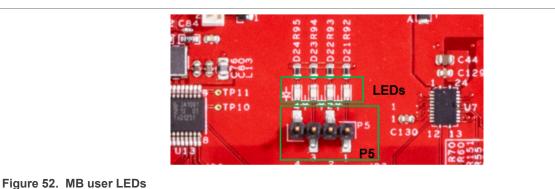


Figure 51. Physical PSI5 connector

#### 4.8 User LEDs

There are four yellow user LEDs on the motherboard, connected via header P5. Each LED will turn ON when its corresponding header pin is pulled to ground.

S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide



These pins on P5 can be connected to via any GPIO pin with the user of jumper wires.

#### 4.9 User inputs

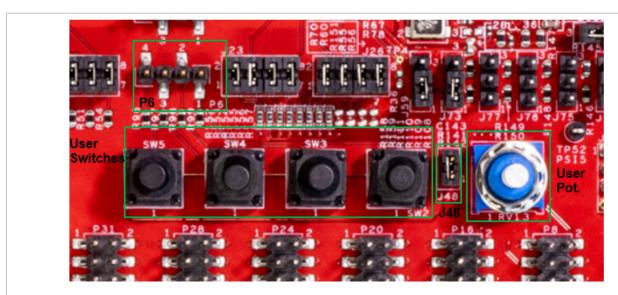


Figure 53. Motherboard user inputs

#### 4.9.1 Switches

There are four user pushbutton switches on the motherboard, each connected via header P6. User can connect any GPIO from the headers to P6 using jumper wires. When a switch is pressed the header pin is high (3.3V), and when released, the pin is low.

#### 4.9.2 Potentiometer

There is a 2K potentiometer on the motherboard, connected to header J48. This is not connected to any MCU pin on the daughtercard but is available on the general access headers on the motherboard. This is connected to analog ground for isolation.

#### 4.10 Motor control

There is a separate motor control connector available on the motherboard, located in the bottom right of the board.

UG10281

#### S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

**Note:** This connector is not used with S32Z2/E2 Family MCUs. A separate daughtercard, S32E288-975EVB, includes two motor-control connectors for use with NXP motor kits.



S32SDEV-CON motor control connector cable and socket

#### 4.11 Other connectors

There are general access connectors available that allow easy access to MCU GPIO pins that are not dedicated to other purposes on the daughter-card.

# 5 Revision history

Table 20. Revision history

Document ID	Release date	Description
UG10281 v.1.0	10 July 2025	Initial release

#### S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

# **Legal information**

#### **Definitions**

**Draft** — A draft status on a document indicates that the content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included in a draft version of a document and shall have no liability for the consequences of use of such information.

#### **Disclaimers**

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the Terms and conditions of commercial sale of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors and its suppliers accept no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

**Applications** — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at https://www.nxp.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

**Export control** — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Suitability for use in non-automotive qualified products — Unless this document expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

**HTML publications** — An HTML version, if available, of this document is provided as a courtesy. Definitive information is contained in the applicable document in PDF format. If there is a discrepancy between the HTML document and the PDF document, the PDF document has priority.

**Translations** — A non-English (translated) version of a document, including the legal information in that document, is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

Security — Customer understands that all NXP products may be subject to unidentified vulnerabilities or may support established security standards or specifications with known limitations. Customer is responsible for the design and operation of its applications and products throughout their lifecycles to reduce the effect of these vulnerabilities on customer's applications and products. Customer's responsibility also extends to other open and/or proprietary technologies supported by NXP products for use in customer's applications. NXP accepts no liability for any vulnerability. Customer should regularly check security updates from NXP and follow up appropriately. Customer shall select products with security features that best meet rules, regulations, and standards of the intended application and make the ultimate design decisions regarding its products and is solely responsible for compliance with all legal, regulatory, and security related requirements concerning its products, regardless of any information or support that may be provided by NXP.

NXP has a Product Security Incident Response Team (PSIRT) (reachable at <a href="PSIRT@nxp.com">PSIRT@nxp.com</a>) that manages the investigation, reporting, and solution release to security vulnerabilities of NXP products.

**NXP B.V.** — NXP B.V. is not an operating company and it does not distribute or sell products.

#### **Trademarks**

Notice: All referenced brands, product names, service names, and trademarks are the property of their respective owners.

NXP — wordmark and logo are trademarks of NXP B.V.

UG10281

All information provided in this document is subject to legal disclaimers.

© 2025 NXP B.V. All rights reserved.

# S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

# **Tables**

Tab. 1.	RCON settings to select the corresponding		Tab. 12.	MCU GPIO pin numbers for SDHC signals	25
	flash memory	7	Tab. 13.	Enable/disable headers for MB power rails	35
Tab. 2.	RCON settings to select the corresponding		Tab. 14.	Default DC CAN mapping and MCU GPIO	
	SD/MMC boot	7		pin numbers for MB CAN instances 0-3	36
Tab. 3.	Additional RCON settings for Clock/Speed/		Tab. 15.	MCU CAN instance and GPIO pin numbers	
	Phase for different boot configurations	8		for MB CAN instances 4-7	37
Tab. 4.	List of jumpers	10	Tab. 16.	MCU LIN module and GPIO pin numbers	
Tab. 5.	0.8V Power supply options	15		for MB LIN signals	38
Tab. 6.	5.0V Power supply options		Tab. 17.	MCU GPIO pin numbers for FlexRay	
Tab. 7.	3.3V Power supply options			signals	39
Tab. 8.	1.1V Power supply options		Tab. 18.	TJA1081 FlexRay transceiver module	
Tab. 9.	1.8V Power supply options			mode select	
Tab. 10.	1.8V Power supply options	16	Tab. 19.	MCU GPIO pin numbers for PSI5 signals	
Tab. 11.	Summary of resistor positions for different		Tab. 20.	Revision history	43
	clocks	21			
Figur	es				
Fig. 1.	Detailed S32E2 system diagram	2	Fig. 27.	S32E288-975EVB Daughtercard CAN0	
Fig. 2.	S32X-MB			and CAN1	24
Fig. 3.	S32E288-975EVB daughtercard	3	Fig. 28.	CANXL connector	25
Fig. 4.	S32X-MB and S32E288-975EVB		Fig. 29.	Micro SD socket	26
	daughtercard	4	Fig. 30.	S32E2- DC daughtercard EEPROM	
Fig. 5.	Jumpers J124 and J125 for boot mode			schematic	27
	selection	5	Fig. 31.	Physical EEPROM	27
Fig. 6.	Jumper J247 for selecting LIN(9) for UART	6	Fig. 32.	RGMII ethernet PHYs	28
Fig. 7.	RCON switches	7	Fig. 33.	S32E288-975EVB daughtercard aurora	
Fig. 8.	S32X-MB and S32E288-975EVB			connector schematic	29
	daughtercard		Fig. 34.	NXP arm high speed aurora trace	
Fig. 9.	Highlighted default jumper settings			connector definition	
Fig. 10.	LED power indicators	13	Fig. 35.	JTAG connector schematic	
Fig. 11.	Daughter-card power trees for PF5030		Fig. 36.	Lauterbach hardware setup	
	PMIC	14	Fig. 37.	DSPI header	
Fig. 12.	JPx jumper		Fig. 38.	On-board serial flash	
Fig. 13.	Physical power supply selection jumper	15	Fig. 39.	Serial flash schematics	
Fig. 14.	Example of daughtercard supply selection		Fig. 40.	Overview of component placement on EVB	
	jumpers		Fig. 41.	Default configurations of motherboard	
Fig. 15.	Contacts for individual external supplies		Fig. 42.	Motherboard power supply diagram	
Fig. 16.	12V Connections into FS86 SBC		Fig. 43.	Physical motherboard power connectors	35
Fig. 17.	SBC and PMIC jumpers		Fig. 44.	Physical CAN connectors (default	
Fig. 18.	DC clocking configuration schematic			configuration labelling)	
Fig. 19.	Physical DC clocking configuration-1		Fig. 45.	J21 CAN 4-7 MCU access	
Fig. 20.	Physical DC clocking configuration-2		Fig. 46.	Physical LIN connectors	
Fig. 21.	POR RESET switch on DC	22	Fig. 47.	J63 UART Connector	
Fig. 22.	Functional reset switch on		Fig. 48.	Physical FlexRay connectors	39
	S32E288-975EVB daughtercard	22	Fig. 49.	FlexRay connectors and enable and mode	
Fig. 23.	Default RCON switch positions for flash			select jumpers	
	boot		Fig. 50.	PSI5 interface schematic	
Fig. 24.	USB-UART LIN9		Fig. 51.	Physical PSI5 connector	
Fig. 25.	LIN switch schematic		Fig. 52.	MB user LEDs	
Fig. 26.	RCON switch schematic	24	Fig. 53.	Motherboard user inputs	42

# S32E288-975EVB Evaluation Board Solution for S32E2 Family Microcontrollers User Guide

4.9.1 4.9.2

4.10 4.11 **5** 

# **Contents**

1	Overview	
2	Boot modes	4
2.1	Introduction	
2.2	Serial boot mode	4
2.2.1	FlexCAN	
2.2.2	UART(LINFlexD)	
2.3	Boot from external flash memory	
2.3.1	QSPI boot mode	
2.3.1	SD/MMC/eMMC via uSDHC interface	
2.3.3	Additional RCON settings for Clock/Speed/	/
2.3.3	Phase for different boot configurations	7
•		
3	Daughtercard	9
3.1	Default jumper settings (DC)	9
3.2	Power supply	13
3.2.1	Power from motherboard	
3.2.2	Power from multiple external supplies	
3.2.3	Power from SBC/PMIC	
3.2.4	SBC debug mode	
3.3	Clock and reset	20
3.3.1	Clocking	20
3.3.1.1	40MHz Crystal	21
3.3.1.2	40MHz OSC	21
3.3.1.3	External SMA	
3.3.2	Reset	
3.3.2.1	POR RESET	
3.3.2.2	Functional reset	
3.4	RCON switches	
3.5	LIN	
3.6	CAN	
3.7	CAN-XL	
	SDHC	
3.8		
3.9	EEPROM	
3.10	Ethernet	
3.11	Debug	
3.11.1	Aurora	
3.11.2	JTAG	
3.11.3	Lauterbach debuggers	
3.11.4	OpenSDA	
3.11.5	Other	31
3.12	SPI	31
3.13	Flash	31
4	Motherboard	32
4.1	Power supply	34
4.2	CAN	
4.2.1	CAN 0-3	
4.2.2	CAN 4-7	
4.3	LIN	
4.4	USB/UART	
4.5		
	FlexRay	
4.6	Ethernet	
4.7	PSI5	
4.8	User LEDs	
4.9	User inputs	42

Switches	42
Potentiometer	42
Motor control	42
Other connectors	43
Revision history	43
Legal information	

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

Document feedback